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Erratum: "Silicon electronics on silk as a path to bioresorbable, implantable devices" [Appl. Phys. Lett. 95, 133701 (2009)]

Dae-Hyeong Kim,[1] Yun-Soung Kim,[1] Jason Amsden,[2] Bruce Panilaitis,[2]
David L. Kaplan,[2] Fiorenzo G. Omenetto,[2] Mitchell R. Zakin,[3] and John A. Rogers[1,4,a)]
[1]*Department of Materials Science and Engineering, Beckman Institute, and Frederick Seitz Materials Research Laboratory, University of Illinois at Urbana-Champaign, 1304 West Green Street, Urbana, Illinois 61801, USA*
[2]*Department of Biomedical Engineering, Tufts University, Medford, Massachusetts 02155, USA*
[3]*Defense Advanced Research Projects Agency, Arlington, Virginia 22203, USA*
[4]*Department of Chemistry, Department Electrical and Computer Engineering, and Department Mechanical Science and Engineering, University of Illinois at Urbana-Champaign, 1304 West Green Street, Urbana, Illinois 61801, USA*

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a) Author to whom correspondence should be addressed. Electronic mail: jrogers@uiuc.edu.